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# WMED 2015 Table of Contents

<b>Welcome to IEEE WMED 2015</b> .....	vii
<b>WMED 2015 Organizing Committee</b> .....	viii
<b>WMED 2015 Technical Program</b> .....	ix
<b>WMED 2015 Keynote, Plenary Talk, Invited Tutorials, and Invited Talks</b> .....	N/A

## **Keynote Address**

<b>6th Sense: Making Wearable Technology to Enhance Human Perception</b> .....	xiv
<i>Dr. Lakshman Krishnamurthy, Intel Corporation</i>	

## **Keynote Talk**

<b>Materials and Patterning Challenges in 3D Device Architectures</b> .....	xv
<i>Dr. Bradley Howard, Applied Materials</i>	

## **Invited Tutorials**

<b>From Concept of FinFET to the Future</b> .....	xvi
<i>Prof. Chenming Hu, University of California, Berkeley</i>	
<b>Clocking Architecture &amp; Circuit Techniques for Multi-Gb/s I/O</b> .....	xvii
<i>Dr. Mozghan Mansuri, Intel Corporation</i>	

## **Invited Talks**

<b>Introduction to Spin-transfer Torque MRAM Technology and Materials</b> .....	xviii
<i>Dr. Guohan Hu, IBM</i>	
<b>3D Memory Systems and Million IOP Solid State Drives</b> .....	xix
<i>Joe Jeddloh, Micron Technology Inc.</i>	
<b>Emerging Frontier in Electronics: System Scaling for Smart, Wearable, IOT and Miniaturized Medical Systems</b> .....	xx
<i>Prof. Rao R Tummala, Georgia Institute of Technology</i>	
<b>Technology and Circuit Co-design in nm Era for Low Power Conundrum</b> .....	xxi
<i>Dr. Rajiv V. Joshi, IBM</i>	
<b>Virtual Fabrication for Advanced Technology Development</b> .....	xxii
<i>Ken Greiner, Coventor</i>	

# WMED 2015 Table of Contents

## Contributed Papers: Session 1

<b>Salicidation Processes and CoSi<sub>2</sub> Resistance Study</b> .....	1
<i>Lifang Xu, Alan Shafi, Mark Meldrim, Zengtao Liu, Yudong Kim, and Nikhil Rangaraju</i>	
<b>Controlled Formation of Square Crack in Thinned 3DI Silicon Wafers</b> .....	4
<i>Ahmed Abdelnaby, Randall Parker, Pavan Chennapragada, Sameer Vadhavkar, Wayne Huang, Michael Brand, Sony Varghese, and Ross Dando</i>	
<b>Study of Channeling and Self-Sputtering Effects of Ion Implantation – Data and Modeling</b> .....	8
<i>Shu Qin and Yushi Hu</i>	
<b>"Atomistic" Dopant Profiling using Scanning Capacitance Microscopy</b> .....	12
<i>Samira Aghaei, Petru Andrei, and Mark Hagmann</i>	

## Contributed Papers: Session 2

<b>Design Analysis of a 12.5 GHz PLL in 130 nm SiGe BiCMOS Process</b> .....	16
<i>Kehan Zhu, Vishal Saxena, Xinyu Wu, and Sakkarapani Balagopal</i>	
<b>Passivity Verification and Macromodel Interpolation using Singular Value Decomposition (SVD)</b> .....	20
<i>Dalia Elgamel, Roy Greeff, and David Ovard</i>	
<b>A Study of Differential Signaling: Stable and Accurate Mixed-Mode Conversion and Extraction of Differential S-Parameters</b> .....	24
<i>Hung Tran, Lyudmyla L. Barannyk, Aicha Elshabini, and Fred Barlow</i>	
<b>Low-Noise CMOS Bandgap Reference Generator Using Two-Level Chopping Technique</b> .....	28
<i>Bingxing Wu and Suat U. Ay</i>	

## Poster Session

<b>Nanostructured Polymer Lithography for Photovoltaic Applications</b> .....	34
<i>Allison J. Christy, Nicholas L. McKibben, Jerry D. Harris, and David Estrada</i>	
<b>Optimizing Au Wirebonding Recipes for Flexibility in a Prototype Assembly Shop</b> .....	56
<i>Hassan Masood, Aaron Collins, Austin Doutre, and Stevan Hunter</i>	
<b>Nanofabrication of Field Emitter Diodes Operating in Air to Generate Terahertz Radiation</b> .....	35
<i>Kai Yang, Mark Hagmann, and Berardi Sensale Rodriguez</i>	

# WMED 2015 Table of Contents

## **Poster Session** Cont'd

<b>Removal of Organic Sacrificial Layers in MEMS Device Manufacturing</b> .....	35
<i>Yin Xu, Vlad Tarasov, Wei Chen, and Koukou Suu</i>	
<b>Gold Wirebond Study on Wafer Fab Process Margins Experiment, with and without Polyimide</b> .....	36
<i>Ikhoon Shin, Aaron Collins, and Stevan Hunter</i>	
<b>Random Doping Effects on the Small-Signal Capacitance in 3-D Nanoscale Structures</b> .....	38
<i>Samira Aghaei, Petru Andrei, and Mark Hagmann</i>	
<b>Polysilicon Resistor Process Control Improvement</b> .....	37
<i>Zoma Zaman and Steven Hunter</i>	
<b>Approximation of the Upper Usable Frequency for Point-contact MIM Diodes from dc I-V Measurements</b> .....	39
<i>Glade Snyder, Chad Rhoades, and Mark J. Hagmann</i>	
<b>Measurement of Frequency Comb from 500 Hz to 2 THz with 4x10<sup>9</sup> Harmonics and Simulation of Modulation for Extremely High Data Rate</b> .....	38
<i>J. D. Rasmussen, M. J. Hagmann, and T. Henage</i>	
<b>Polyimide Adverse Effect on Au Wirebond Shear Test Results for Al Bond Pads</b> .....	38
<i>Aaron Collins, Ikhoon Shin, and Stevan Hunter</i>	
<b>Application of Scanning Frequency Comb Microscopy for Sub-nm Carrier Profiling in Semiconductors</b> .....	39
<i>Mark Hagmann, Petru Andrei, Shashank Pandey and Ajay Nahata</i>	
<b>Harmonic Frequency Drift Tracking</b> .....	38
<i>T. Henage, M. J. Hagmann, and J. D. Rasmussen</i>	
<b>Analysis of Subthreshold Behavior of SOI NMOS Device Considering Back-Gate Bias-Related Floating Body Effect</b> .....	38
<i>S. K. Hu and J. B. Kuo</i>	
<b>Silsesquioxane Hybrid Nano-Building Blocks for Extreme Ultra-Violet Photoresists</b> .....	40
<i>Brandon Hardie and Mark Roll</i>	
<b>MakerSat: a DIY CubeSat 3D Printed on the ISS Open-Source Space Research Platform</b> .....	41
<i>Stephen Parke, Joshua Griffin, Keith Moilanen, Braden Grim, and Mitch Kamstra</i>	

## **Author Index**